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(54) Titre : METHODE POUR L'OBTENTION D'UN VERRE DE VOLUME VARIABLE, PAR RAYONNEMENT
 ULTRAVIOLET
 (54) Title: GLASS MATERIAL VARIABLE IN VOLUME BY IRRADIATION WITH ULTRAVIOLET LIGHT

(57) **Abrégé/Abstract:**

A glass material variable in volume by irradiation with ultraviolet light has a GeO₂-SiO₂ glass composition having a GeO₂ content of 0.5 to 90 mol %, and is in the form of a thin film formed in an argon atmosphere or in an argon-oxygen mixed gas atmosphere by the high-frequency sputtering method.

Abstract of the Disclosure:

A glass material variable in volume by irradiation with ultraviolet light has a $\text{GeO}_2\text{-SiO}_2$ glass composition having a GeO_2 content of 0.5 to 90 mol %, and is in the form of a thin film formed in an argon atmosphere or in an argon-oxygen mixed gas atmosphere by the high-frequency sputtering method.

GLASS MATERIAL VARIABLE IN VOLUME BY
IRRADIATION WITH ULTRAVIOLET LIGHT

Background of the Invention:

The present invention relates to a glass material
5 variable in volume by irradiation with ultraviolet
light (hereinafter often referred to as a "variable-
volume glass material").

A silica glass capable of transmitting light in
the ultraviolet to near infrared range is used as the
10 matrix of an optical communication fiber, the core
portion of which is usually doped with GeO_2 . It has
been found out that this optical fiber is increased by
about 1×10^{-4} in the refractive index of the core
thereof when irradiated with an argon ion laser beam
15 of 488 nm in wavelength or an excimer laser beam of
248 nm in wavelength (K. O. Hill et al., Applied
Physics Letters, Vol. 32, No. 10, 1978, P.P. 647 ~
649, and R. M. Atkins et al., Electronics Letters,
1993, Vol. 29, No. 4, P.P. 385 ~ 387). It has been
20 reported that the mechanism of refractive index change
is sequential occurrence of two processes: (1) that
structural defects are induced in the glass by light
to bring about strong absorption in the ultraviolet
range, and (2) that the density of the glass is
25 increased, i.e., the volume thereof is decreased due
to formation of the structural defects.

A refractive index change is also recognized in a
GeO₂-SiO₂ glass produced by the sol-gel method (K. D.
Simmon et al., Optics Letter, 1993, Vol. 18, No. 1,
P.P. 25 ~ 27). In this case, however, the amount of
5 refractive index change is no more than about 3×10^{-5} .

In both the foregoing cases, therefore, a
difficulty is encountered in applying the glass to a
hologram and the like in which cases a level of 10^{-2} is
required as the amount of refractive index change.

10 Further, ion exchange, crystallization, etc. have
been proposed as means for realizing an increase in
the volume of glass by irradiation thereof with light.
However, there are no reports on a glass wherein
volume expansion thereof can be induced by irradiation
15 thereof with light at room temperature while keeping
it in an amorphous state.

Summary of the Invention:

Accordingly, a principal object of the present
invention is to provide a glass material wherein
20 volume expansion thereof by a level of 10^{-2} can be
induced by irradiation thereof with ultraviolet light
at room temperature while keeping it in an amorphous
state.

As a result of intensive investigations made
25 having regard to the foregoing status of the prior
art, the inventors of the present invention have found

out that the foregoing object can be attained when a glass having a specific composition is used to form a thin glass film in a specific gas atmosphere controlled in oxygen content by the high-frequency sputtering method.

Specifically, the present invention provides a glass material wherein a volume change thereof by a level of 10^{-2} can be induced by irradiation thereof with ultraviolet light, and particularly a glass material variable in volume by irradiation with ultraviolet light which material has a $\text{GeO}_2\text{-SiO}_2$ glass composition having a GeO_2 content of 0.5 to 90 mol %, and is in the form of a thin film formed in an argon atmosphere or in an argon-oxygen mixed gas atmosphere having an oxygen content of at most 20 vol. % by the high-frequency sputtering method.

In a thin $\text{GeO}_2\text{-SiO}_2$ glass film formed under specific conditions by the high-frequency sputtering method according to the present invention, an increase by a level of 10^{-2} in the volume thereof can be induced by irradiation thereof with an ultraviolet laser beam at room temperature while keeping it in an amorphous state. Accordingly, it is applicable to an optical memory, a hologram recording medium, etc.

Brief Description of the Drawing:

Fig. 1 is a two-dimensional diagram showing a

change in the refractive index of the glass material of the present invention and a change in the thickness thereof after the glass material is irradiated with ultraviolet radiation.

5 Description of the Preferred Embodiments:

The optical induction variable-volume glass material made of $\text{GeO}_2\text{-SiO}_2$ glass according to the present invention is obtained in the form of a thin film on a substrate such as a single silicon crystal
10 by the high-frequency sputtering method. $\text{GeO}_2\text{-SiO}_2$ glass is especially useful since it is high in transparency in the visible light range and excellent in chemical durability and mechanical durability.

A $\text{GeO}_2\text{-SiO}_2$ glass having a Ge_2O content of 0.5 to
15 90 mol %, preferably 3 to 60 mol %, is especially suitably used as such glass. When the GeO_2 content is too low, the $\text{GeO}_2\text{-SiO}_2$ glass cannot secure a large volume change when irradiated with light. On the other hand, when it is too high, the glass is
20 sometimes colored yellow or lowered in water resistance.

High-frequency sputtering can be effected in an argon or argon-oxygen mixed gas atmosphere (oxygen content: at most 20 vol. %, preferably at most 10 vol.
25 %) according to a customary method though conditions thereof are not particularly limited. When the oxygen

content of the argon-oxygen mixed gas atmosphere exceeds 20 vol. %, a thin film having the desired feature of being variable in volume by irradiation thereof with ultraviolet light cannot be obtained.

5 The thickness of the thin glass film is usually about 0.1 to 10 μm (100 to 100,000 \AA).

The thin film thus obtained may be heat-treated in vacuo or in an inert gas such as argon or nitrogen at 200 to 800 $^{\circ}\text{C}$, preferably 300 to 650 $^{\circ}\text{C}$, for the
10 purpose of adjusting the volume change thereof and improving the laser beam resistance, etc. thereof.

The light usable for inducing volume expansion of the thin film is preferably an ultraviolet light of at most 400 nm in wavelength. A more specific preferable
15 light source is a pulse laser of at least 1 mJ/cm^2 in energy density, examples of which include an argon-fluorine (ArF) excimer laser of 193 nm in wavelength, a krypton-fluorine (KrF) excimer laser of 248 nm in wavelength, a xenon-chlorine (XeCl) excimer laser of
20 308 nm in wavelength, a xenon-fluorine (XeF) excimer laser of 350 nm in wavelength, and yttrium-aluminum-garnet (YAG) lasers respectively emitting third harmonics (355 nm) and fourth harmonics (266 nm).

The features of the present invention will now be
25 made clearer while showing Examples and Comparative Examples.

Example 1:

A thin glass film of 33 mol % GeO_2 -67 mol % SiO_2 was deposited on a single silicon crystal substrate at a rate of about 8 nm/min over about 15 minutes under conditions involving a gas atmosphere composition of 100% argon (Ar), a gas flow rate of 3 cc/min and a pressure of about 10^{-2} Torr in a chamber. Desired adjustment of the composition of the thin film was confirmed by XPS (X-ray photoelectron spectroscopy).

Further, a thin film of about 6 μm in thickness was formed on a SiO_2 glass substrate according to substantially the same procedure as described above, and then examined by X-ray diffractometry to observe no sharp diffraction peaks assigned to GeO_2 or SiO_2 .

The thin glass film thus obtained was heat-treated in vacuo at 500°C for 1 hour, and then irradiated with 1,200 ArF excimer laser beam pulses of 248 nm in wavelength and 10 mJ/cm^2 in power density. Thereafter, the refractive index of it was examined with an ellipsometer using an He-Ne laser of 633 nm in wavelength as the light source. The results are shown in Fig. 1.

As is apparent from Fig. 1, it was confirmed that the thin film was increased by about 8% in thickness, i.e., volume, in the region thereof irradiated with

the laser beam to be thereby decreased by about 1.2%
in refractive index.

Example 2:

A thin glass film of 50 mol % GeO_2 -50 mol % SiO_2
5 formed in substantially the same manner as in Example
1 was heat-treated in an argon atmosphere at 500°C for
1 hour, and then irradiated with the same excimer
laser beam pulses as in Example 1. Thereafter, the
refractive index of it was examined with the
10 ellipsometer using the He-Ne laser of 633 nm in
wavelength as the light source. As a result, it was
confirmed that the thin film was increased by about
10% in thickness in the region thereof irradiated with
the laser beam to be thereby decreased by about 1.5%
15 in refractive index.

Example 3:

A thin film formed using a glass having a 5 mol %
 GeO_2 -95 mol % SiO_2 glass composition in substantially
the same manner as in Example 1 was heat-treated in
20 vacuo at 500°C for 1 hour, and then irradiated with
1,400 ArF excimer laser beam pulses in substantially
the same manner as in Example 1. Thereafter, the
refractive index of it was examined with the
ellipsometer using the He-Ne laser of 633 nm in
25 wavelength as the light source. As a result, it was
confirmed that the thin film was increased by 1% in

thickness in the region thereof irradiated with the laser beam to be thereby decreased by 0.15% in refractive index.

Example 4:

5 A thin film formed using a glass having a 55 mol % GeO_2 -45 mol % SiO_2 glass composition in substantially the same manner as in Example 1 was heat-treated in vacuo at 500°C for 1 hour, and then irradiated with 1,100 XeCl excimer laser beam pulses in substantially
10 the same manner as in Example 1. Thereafter, the refractive index of it was examined with the ellipsometer using the He-Ne laser of 633 nm in wavelength as the light source. As a result, it was confirmed that the thin film was increased by 6% in
15 thickness in the region thereof irradiated with the laser beam to be thereby decreased by 0.9% in refractive index.

Example 5:

 A thin film formed using a glass having a 20 mol
20 % GeO_2 -80 mol % SiO_2 glass composition in substantially the same manner as in Example 1 was heat-treated in vacuo at 500°C for 1 hour, and then irradiated with 1,400 KrF excimer laser beam pulses in substantially the same manner as in Example 1. Thereafter, the
25 refractive index of it was examined with the ellipsometer using the He-Ne laser of 633 nm in

wavelength as the light source. As a result, it was confirmed that the thin film was increased by 5% in thickness in the region thereof irradiated with the laser beam to be thereby decreased by 0.75% in refractive index.

Example 6:

A thin film formed using a glass having a 55 mol % GeO_2 -45 mol % SiO_2 glass composition in substantially the same manner as in Example 1 was heat-treated in vacuo at 500°C for 1 hour, and then irradiated with 1,100 YAG laser beam pulses of 266 nm in wavelength in substantially the same manner as in Example 1.

Thereafter, the refractive index of it was examined with the ellipsometer using the He-Ne laser of 633 nm in wavelength as the light source. As a result, it was confirmed that the thin film was increased by 4% in thickness in the region thereof irradiated with the laser beam to be thereby decreased by 0.6% in refractive index.

Comparative Example 1:

A thin SiO_2 glass film was deposited on a single silicon crystal substrate at a rate of about 8 nm/min over about 15 minutes under conditions involving a gas atmosphere composition of 100% argon (Ar), a gas flow rate of 3 cc/min and a pressure of about 10^{-2} Torr in a chamber.

The thin glass film thus obtained was irradiated with 6,000 ArF excimer laser beam pulses of 248 nm in wavelength and 10 mJ/cm² in power density. Thereafter, the refractive index of it was examined with the
5 ellipsometer using the He-Ne laser of 633 nm in wavelength as the light source to recognize no change in the refractive index thereof.

Comparative Example 2:

A 33 mol % GeO₂-67 mol % SiO₂ glass was deposited
10 on a silicon substrate under substantially the same conditions as in Comparative Example 1, and then irradiated with ArF excimer laser beam pulses of 248 nm in wavelength and 10 mJ/cm² in power density, whereby the surface of the thin film was thermally
15 damaged to make it impossible to evaluate the refractive index thereof with the ellipsometer.

Comparative Example 3:

Sputtering of a 20 mol % GeO₂-80% mol SiO₂ glass on a single silicon crystal substrate was attempted
20 under conditions involving a gas atmosphere composition of 35% O₂-65% argon (Ar), a gas flow rate of 3 cc/min and a pressure of about 10⁻² Torr in a chamber. The deposition rate was very slow. Moreover, no substantial change in the refractive
25 index of the resulting thin glass film by irradiation thereof with light was recognized.

It will be apparent that a wide variety of different embodiments are possible without any departure from the spirit and ambit of the present invention. Accordingly, the present invention is not
5 restricted to the specific embodiments thereof except for the limitations as specified in the appended claims.

CLAIMS:

1. A glass material expansible in volume by irradiation thereof with ultraviolet light, said glass material being reducible in refractive index by irradiation thereof with ultraviolet light, said glass material having a $\text{GeO}_2\text{—SiO}_2$ glass composition having a GeO_2 content of 0.5 to 90 mol %, and is in the form of a thin film formed on a substrate in an argon-oxygen mixed gas atmosphere having an oxygen content of at most 10 vol % by a high-frequency sputtering method, said ultraviolet light having a wavelength of at most 400 nm.
2. A glass material as claimed in claim 1, wherein said GeO_2 content is 3 to 60 mol %.
3. A glass material as claimed in claim 1, wherein said thin film as an intermediate material is heat-treated in vacuo at 200° to 800° C. before the volume change thereof is induced by irradiation with ultraviolet light.
4. A glass material as claimed in claim 3, wherein the heat treatment temperature is 300° to 650° C.

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Fig. 1